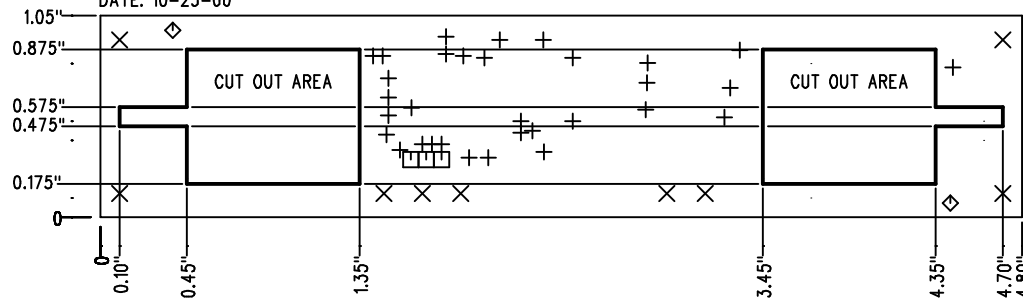


REVISIONS			
REV	DESCRIPTION	APPR	DATE
A	PROTOTYPE RELEASE		

DRILL DRAWING LAYER
LINEAR TECHNOLOGY
DC354A-1 * LT1768GN
HIGH POWER DUAL CCFL
DATE: 10-23-00

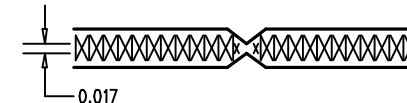


SHOWN FROM COMPONENT SIDE


SIZE	QTY	SYM	PLTD
0.02	32	+	PLTD
0.064	9	X	PLTD
0.035	3	□	PLTD
0.07	2	◇	NPLTD

NOTES : Unless Otherwise Specified

1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD
THICKNESS .062 +/- .006 TOTAL OF 2 LAYERS.
2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE
ELECTRODEPOSITED TIN-LEAD COMPOSITION
BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SMOBC).
3. SOLDER MASK : BOTH SIDES USING LPI OR EQUIVALENT.
4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK.
5. UNUSED SMD COMPONENTS SHOULD BE FREE OF SOLDER.
6. FILL UP ALL VIAS WITH SOLDER.
7. SCORING:



8. PLEASE LOOK AT THE README FILE FOR THE OTHER REQUIREMENTS.

APPROVALS			 LINEAR TECHNOLOGY 1630 McCarthy Blvd. Milpitas, CA 95035 PH: (408)432-1900	
DRAWN	INIT	DATE		
CHECK			TITLE: Fabrication Drawing HIGH POWER DUAL CCFL	
DESIGN	KIM T.	10-20-00		
ENGR	RICH P.	10-20-00	SIZE A DEMO DC354A-1*LT1768GN REV. A	
SCALE = NONE			DES- 0000	SHT 1 of 1